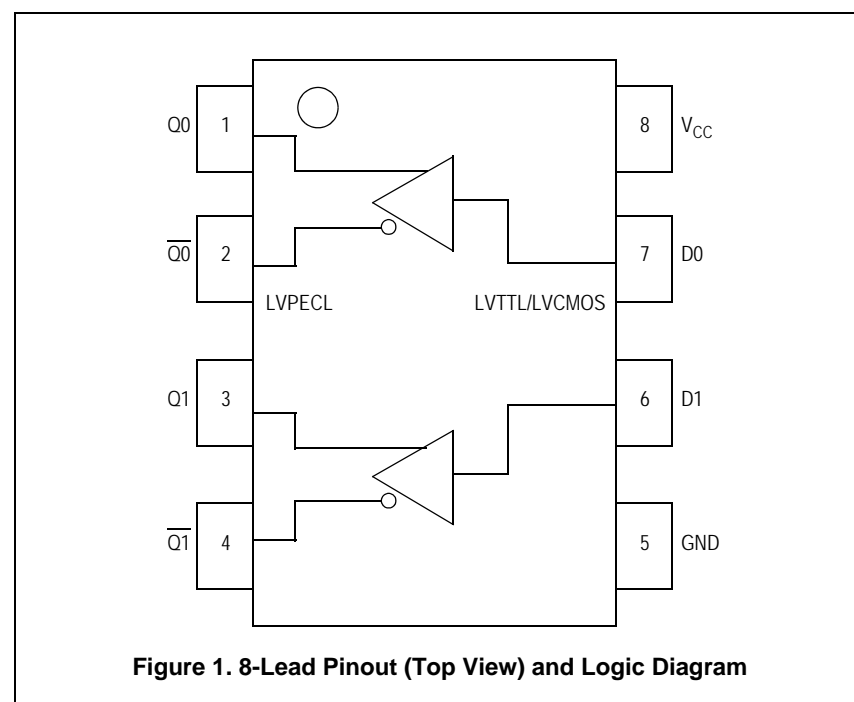


3.3 V Dual LVTTTL/LVCMOS to Differential LVPECL Translator

The MC100ES60T22 is a low skew dual LVTTTL/LVCMOS to differential LVPECL translator. The low voltage PECL levels, small package, and dual gate design are ideal for clock translation applications.

Features

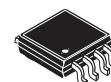
- 280 ps typical propagation delay
- 100 ps max output-to-output skew
- LVPECL operating range: $V_{CC} = 3.135\text{ V to }3.8\text{ V}$
- 8-lead SOIC and 8-lead TSSOP packages
- Ambient temperature range $-40^{\circ}\text{C to }+85^{\circ}\text{C}$



MC100ES60T22



D SUFFIX
8-LEAD SOIC PACKAGE
CASE 751-06



DT SUFFIX
8-LEAD TSSOP PACKAGE
CASE 1640-01

ORDERING INFORMATION

Device	Package
MC100ES60T22D	SOIC-8
MC100ES60T22DR2	SOIC-8
MC100ES60T22DT	TSSOP-8
MC100ES60T22DTR2	TSSOP-8

PIN DESCRIPTION

Pin	Function
D0, D1	LVTTTL/LVCMOS Inputs
$Q_n, \overline{Q_n}$	LVPECL Differential Outputs
V_{CC}	Positive Supply
GND	Negative Supply

Table 1. General Specifications

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Characteristics		Value
Internal Input Pulldown Resistor		75 k Ω
Internal Input Pullup Resistor		75 k Ω
ESD Protection	Human Body Model Machine Model	> 2000 V > 200 V
θ_{JA} Thermal Resistance (Junction-to-Ambient)	0 LFPM, 8 SOIC 500 LFPM, 8 SOIC 0 LFPM, 8 TSSOP 500 LFPM, 8 TSSOP	190°C/W 130°C/W 185°C/W 140°C/W

Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test

Table 2. Absolute Maximum Ratings⁽¹⁾

Symbol	Rating	Conditions	Rating	Units
V_{SUPPLY}	Power Supply Voltage	Difference between V_{CC} & V_{EE}	3.9	V
V_{IN}	Input Voltage	$V_{CC} - V_{EE} \leq 3.6$ V	$V_{CC} + 0.3$ $V_{EE} - 0.3$	V V
I_{out}	Output Current	Continuous Surge	50 100	mA mA
T_A	Operating Temperature Range		-40 to +85	°C
T_{STG}	Storage Temperature Range		-65 to +150	°C

1. Absolute maximum continuous ratings are those maximum values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation at absolute-maximum-rated conditions is not implied.

Table 3. DC Characteristics ($V_{CC} = 3.135$ V to 3.8 V; $V_{EE} = 0$ V)

Symbol	Characteristic	-40°C			0°C to 85°C			Unit
		Min	Typ	Max	Min	Typ	Max	
$V_{OH}^{(1)}$	Output HIGH Voltage	$V_{CC} - 1150$	$V_{CC} - 1020$	$V_{CC} - 800$	$V_{CC} - 1200$	$V_{CC} - 970$	$V_{CC} - 750$	mV
$V_{OL}^{(1)}$	Output LOW Voltage	$V_{CC} - 1950$	$V_{CC} - 1620$	$V_{CC} - 1250$	$V_{CC} - 2000$	$V_{CC} - 1680$	$V_{CC} - 1300$	mV

1. Outputs are terminated through a 50 Ω resistor to $V_{CC} - 2$ volts.

Table 4. LVTTTL / LVCMOS Input DC Characteristics ($V_{CC} = 3.135$ V to 3.8 V)

Symbol	Characteristic	Condition	-40°C			0°C to 85°C			Unit
			Min	Typ	Max	Min	Typ	Max	
I_{IN}	Input Current	$V_{IN} = V_{CC}$			± 150			± 150	μ A
V_{IK}	Input Clamp Voltage	$I_{IN} = -18$ mA			-1.2			-1.2	V
V_{IH}	Input HIGH Voltage		2.0		$V_{CC} + 0.3$	2.0		$V_{CC} + 0.3$	V
V_{IL}	Input LOW Voltage				0.8			0.8	V

Table 5. AC Characteristics ($V_{CC} = 3.134\text{ V}$ to 3.8 V ; $V_{EE} = 0\text{ V}$)

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Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
f_{\max}	Maximum Toggle Frequency			1			1			1	GHz
t_{PLH} , t_{PHL}	Propagation Delay	100	260	400	100	280	400	100	280	450	ps
t_{SKEW}	Skew part-to-part			300			300			350	ps
t_{JITTER}	Cycle-to-Cycle Jitter RMS (1σ)			1			1			1	ps
V_{outPP}	Output Peak-to-Peak Voltage	350	750		350	750		350	750		mV
t_r / t_f	Output Rise/Fall Times (20% – 80%)	50		400	50		400	50		400	ps

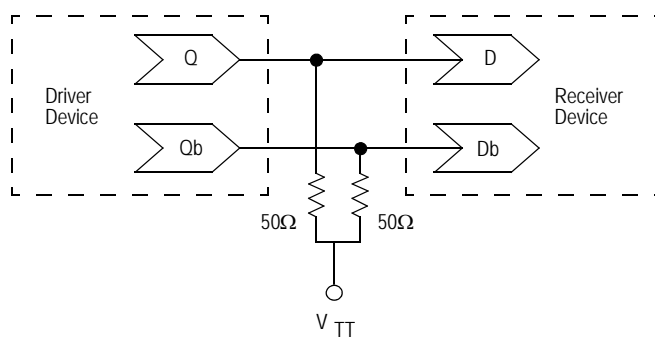
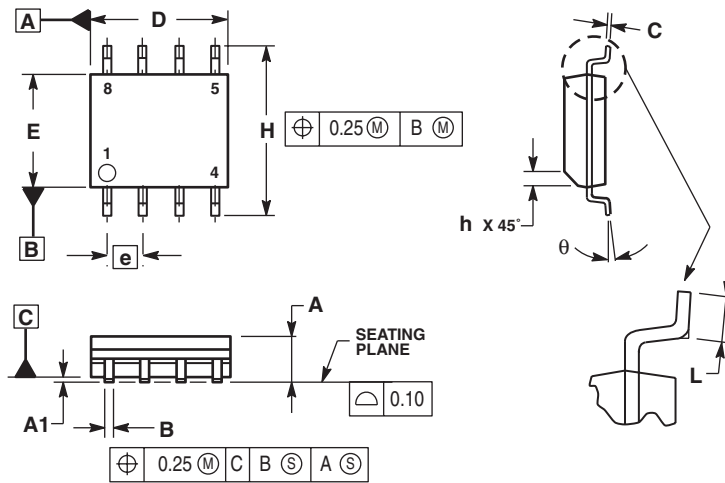


Figure 2. Typical Termination for Output Driver and Device Evaluation

PACKAGE DIMENSIONS

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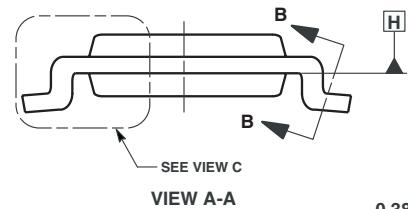
NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. DIMENSIONS ARE IN MILLIMETER.
3. DIMENSION D AND E DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 TOTAL IN EXCESS OF THE B DIMENSION AT MAXIMUM MATERIAL CONDITION.

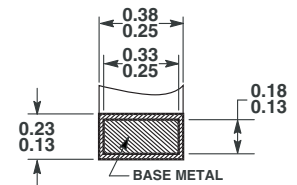
DIM	MILLIMETERS	
	MIN	MAX
A	1.35	1.75
A1	0.10	0.25
B	0.35	0.49
C	0.19	0.25
D	4.80	5.00
E	3.80	4.00
e	1.27 BSC	
H	5.80	6.20
h	0.25	0.50
L	0.40	1.25
θ	0°	7°

**SOIC-8
D SUFFIX
8-LEAD SOIC PACKAGE
CASE 751-06
ISSUE T**

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VIEW A-A



SECTION B-B
SEE NOTE 6

DETAIL "B"
DAMBAR PROTRUSION

TOP VIEW



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. DIMENSIONS ARE IN MILLIMETERS.
 3. THIS DIMENSION DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT DATUM H, MOLD FLASH OR PROTRUSIONS, SHALL NOT EXCEED 0.15mm PER SIDE.
 4. DIMENSION IS THE LENGTH OF TERMINAL FOR SOLDERING TO A SUBSTRATE.
 5. THE LEAD WIDTH DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08mm TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE LEAD FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.14mm SEE DETAIL "B" AND SECTION B-B.
 6. SECTION B-B TO BE DETERMINED AT 0.10 TO 0.25mm FROM THE LEAD TIP.
 7. THIS PART IS COMPLIANT WITH JEDEC REGISTRATION MO-187 AA.
 8. DATUMS A AND B TO BE DETERMINED DATUM PLANE H.

MC100ES60T22

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